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| <b>Form 1449 (Modified)</b><br><br><b>Information Disclosure<br/>Statement By Applicant</b> | <b>Atty Docket No.</b> | <b>IGT1P104/P000897-001</b> |
|   | <b>Application No.</b> | <b>10/810,166</b>           |
|   | <b>Applicant</b>       | <b>Nguyen et al.</b>        |
|   | <b>Filing Date</b>     | <b>March 26, 2004</b>       |
|   | <b>Group</b>           | <b>3714</b>                 |
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|   |                        | <b>Page 1 of 1</b>          |

**U.S. Patent Documents**

| Examiner Initial | No. | Patent No. | Date | Patentee | Class | Sub-class |
|------------------|-----|------------|------|----------|-------|-----------|
|                  |     |            |      |          |       |           |

**Foreign Patent or Published Foreign Patent Application**

| Examiner Initial |  | Document No. | Publication Date | Country or Patent Office | Class | Sub-Class | Translation |    |
|------------------|--|--------------|------------------|--------------------------|-------|-----------|-------------|----|
|                  |  |              |                  |                          |       |           | Yes         | No |
|                  |  |              |                  |                          |       |           |             |    |

**Other Documents**

| Examiner Initial | No. | Author, Title, Place (e.g. Journal) of Publication, Date   |
|------------------|-----|--|
|                  | 1.  | Examination Report from Counterpart Foreign Application No. AU 2005201254, dated November 26, 2009, 2 pages. |

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| <b>Examiner</b> | <b>Date Considered</b> |
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Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.